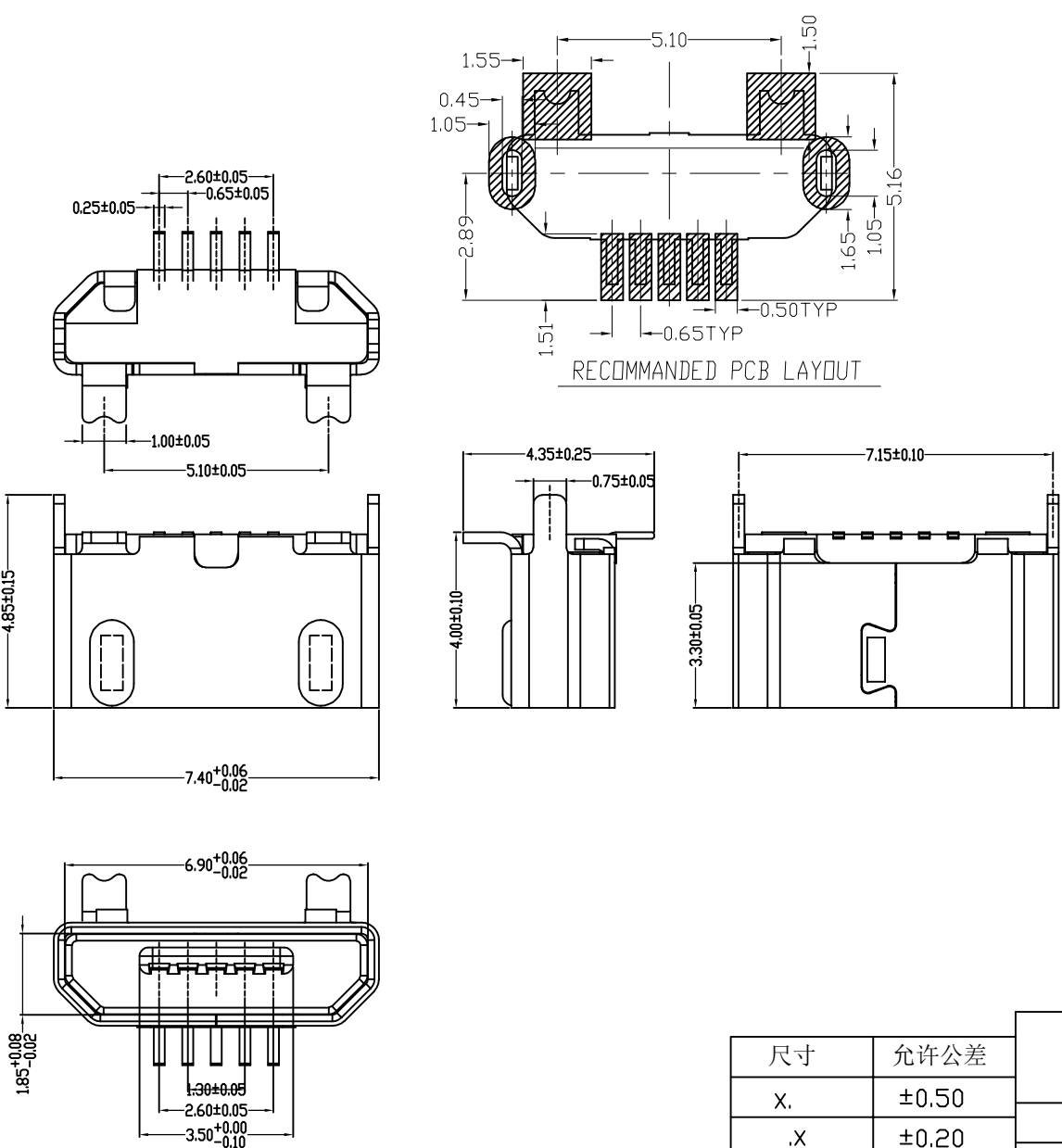


修改序号	修改说明	签名	日期
A/0			



Note:

- Material:
  - Housing: High temperature thermoplastic with g.f, UL94v-0
  - Contact: copper alloy,  $t=0.20\text{mm}$
  - Shell: SUS,  $t=0.25\text{mm}$
- Specification:
  - Current rating: 1.8A Max
  - Voltage rating - 30V DC
  - Dielectric withstanding voltage: 100V (AC) for 1 min.
  - Contact resistance:  $40\text{m}\Omega$  Max.
  - Insulation resistance:  $100\text{M}\Omega$  min.
  - Total mating force: 3.57 Kgf Max.
  - Total unmating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min. after 5,000 insertion/extraction cycles
  - Temperature range:  $-30^{\circ}\text{C}\sim 80^{\circ}\text{C}$
- Materials Used Must Meet RoHS Requirements

尺寸		允许公差		深圳市创勤科技有限公司 SHENZHEN CHUANGQIN TECHNOLOGY CO., LTD.				
X.		$\pm 0.50$						
.X		$\pm 0.20$		图纸类型		图纸名称:		
.XX		$\pm 0.10$		产品工程图		MICRO USB 5Pin BF 180度贴片无柱凸包无卷边L=4.0		
.XXX		$\pm 0.03$		设计	LIN YUN	2018.11.05	产品料号	CQ049-MFLT56492101
角度		$\pm 1.00^{\circ}$		审核			视图	版号: A/0